

N-Ch MOSFET

General Description

Features

Low RDS(on) & FOM

Extremely low switching loss

The WSD40120DN use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness and suitable to use in

Excellent stability and uniformity or Invertors

Product Summery

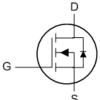
BVDSS	RDSON	ID
40V	1.8mΩ	120A

Applications

- Consumer electronic power supply
- Synchronous-rectification
- Synchronous-rectification applications

DFN5X6-8 Pin Configuration





Absolute Maximum Ratings at Tj=25 °C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	40	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	120	A
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	82	A
I _{DM}	Pulsed Drain Current ²	400	A
EAS	Single Pulse Avalanche Energy ³	400	mJ
I _{AS}	Avalanche Current	40	А
P₀@T₀=25℃	Total Power Dissipation ⁴	125	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{ejA}	Thermal Resistance Junction-Ambient ¹ 50		°C/W	
R _{θJC}	Thermal Resistance Junction-Case ¹		1.0	°C/W



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Electrical Characteristics (T_J=25 $^{\circ}$ C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
$\triangle BV_{DSS} / \triangle T_J$	BV _{DSS} Temperature Coefficient	Reference to 25° C , I _D =1mA		0.043		V/℃
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V_{GS} =10V , I _D =20A		1.4	1.8	mΩ
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =20A		2.0	2.6	mΩ
V _{GS(th)}	Gate Threshold Voltage		1.2	1.6	2.2	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$\nabla_{GS} = \nabla_{DS}$, $D = 2500A$		-6.94		mV/℃
la se	Drain-Source Leakage Current	V_{DS} =32V , V_{GS} =0V , T_{J} =25 $^{\circ}\mathrm{C}$			1	uA
I _{DSS}		V_{DS} =32V , V_{GS} =0V , T_{J} =55 $^{\circ}\mathrm{C}$			5	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =20A		53		S
R _g	Gate Resistance	V_{DS} =0V , V_{GS} =0V , f=1MHz		1.0		Ω
Qg	Total Gate Charge (10V)	V _{DS} =15V , V _{GS} =10V , I _D =20A		45		
Q _{gs}	Gate-Source Charge			12		nC
Q _{gd}	Gate-Drain Charge			18.5		
T _{d(on)}	Turn-On Delay Time			18.5		
Tr	Rise Time	V_{DD} =15V , V_{GEN} =10V , R_{G} =3.3		9		20
T _{d(off)}	Turn-Off Delay Time	Ω, I _D =20A ,RL=15Ω.		58.5		ns -
T _f	Fall Time			32		
C _{iss}	Input Capacitance	V _{DS} =20V , V _{GS} =0V , f=1MHz		3972		
C _{oss}	Output Capacitance			1119		pF
C _{rss}	Reverse Transfer Capacitance			82		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	$V_G = V_D = 0V$, Force Current			100	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1.2	V

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2 .The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3. The EAS data shows Max. rating . The test condition is VDD=25V,VGS=10V,L=0.5mH,IAS=40A 4. The power dissipation is limited by 150°C junction temperature

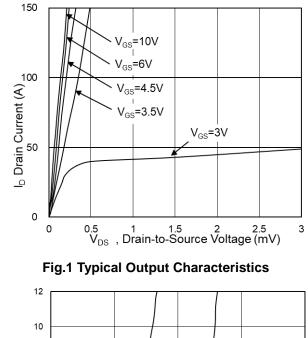
5 .The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

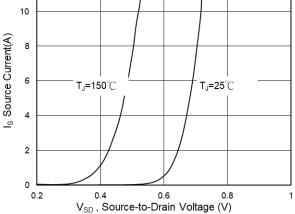


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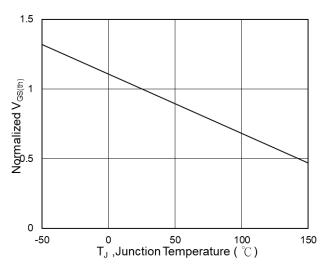
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Typical Characteristics











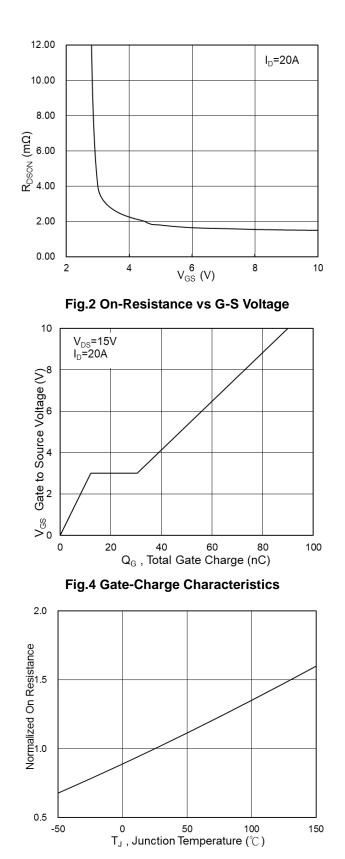


Fig.6 Normalized R_{DSON} vs T_J



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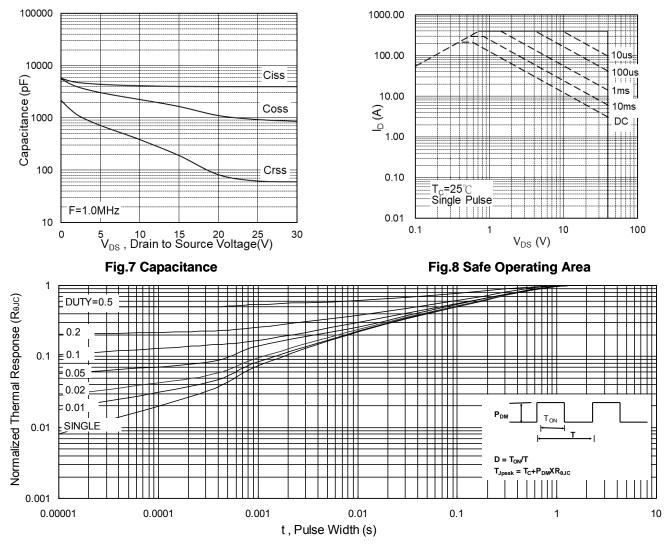
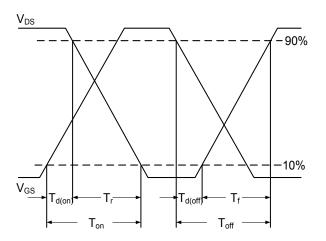


Fig.9 Normalized Maximum Transient Thermal Impedance



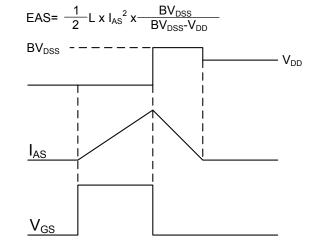


Fig.10 Switching Time Waveform



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